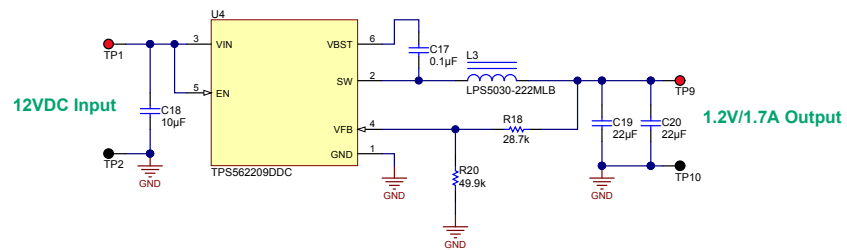


**Assembly Notes:**

- 1) Built on PMP9661 Rev A PCB.



PCB  
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Number: PMP9726	Rev: A	Designed for:	Mod. Date: 5/1/2014
SVN Rev: Not in version control		Project Title: 12Vin, 1.2V/1.7A Sync Buck	
Drawn By:		Sheet Title:	
Engineer: B King		Assembly Variant: 001	Sheet: 1 of 1
		File: PMP9726_REVA_SchDoc	Size: B
		Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	

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